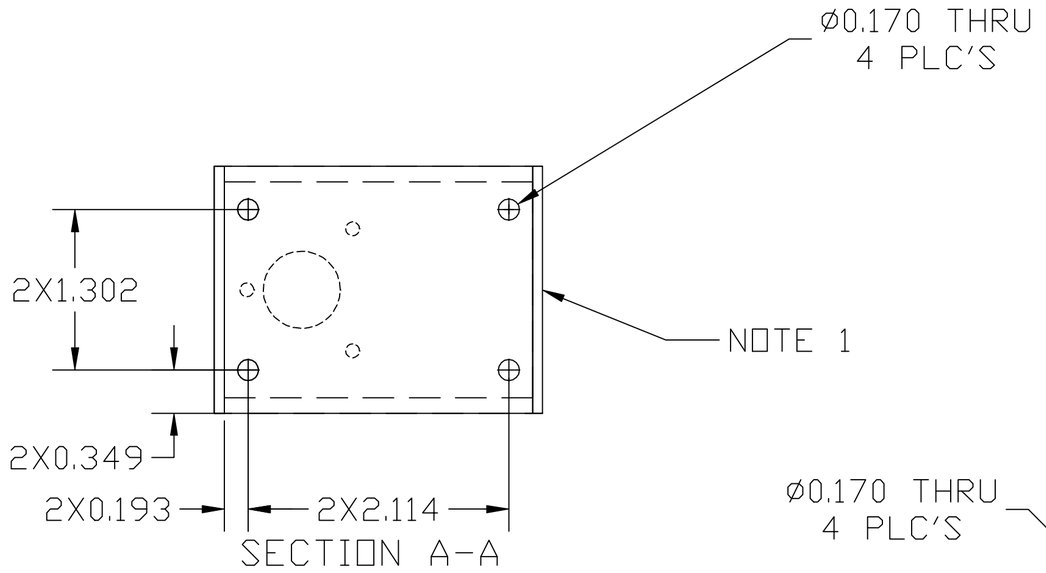
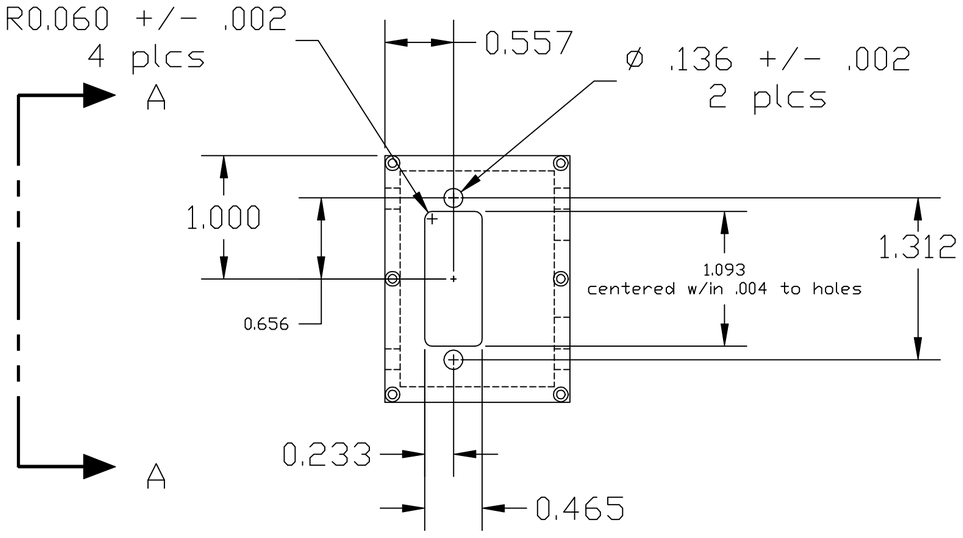
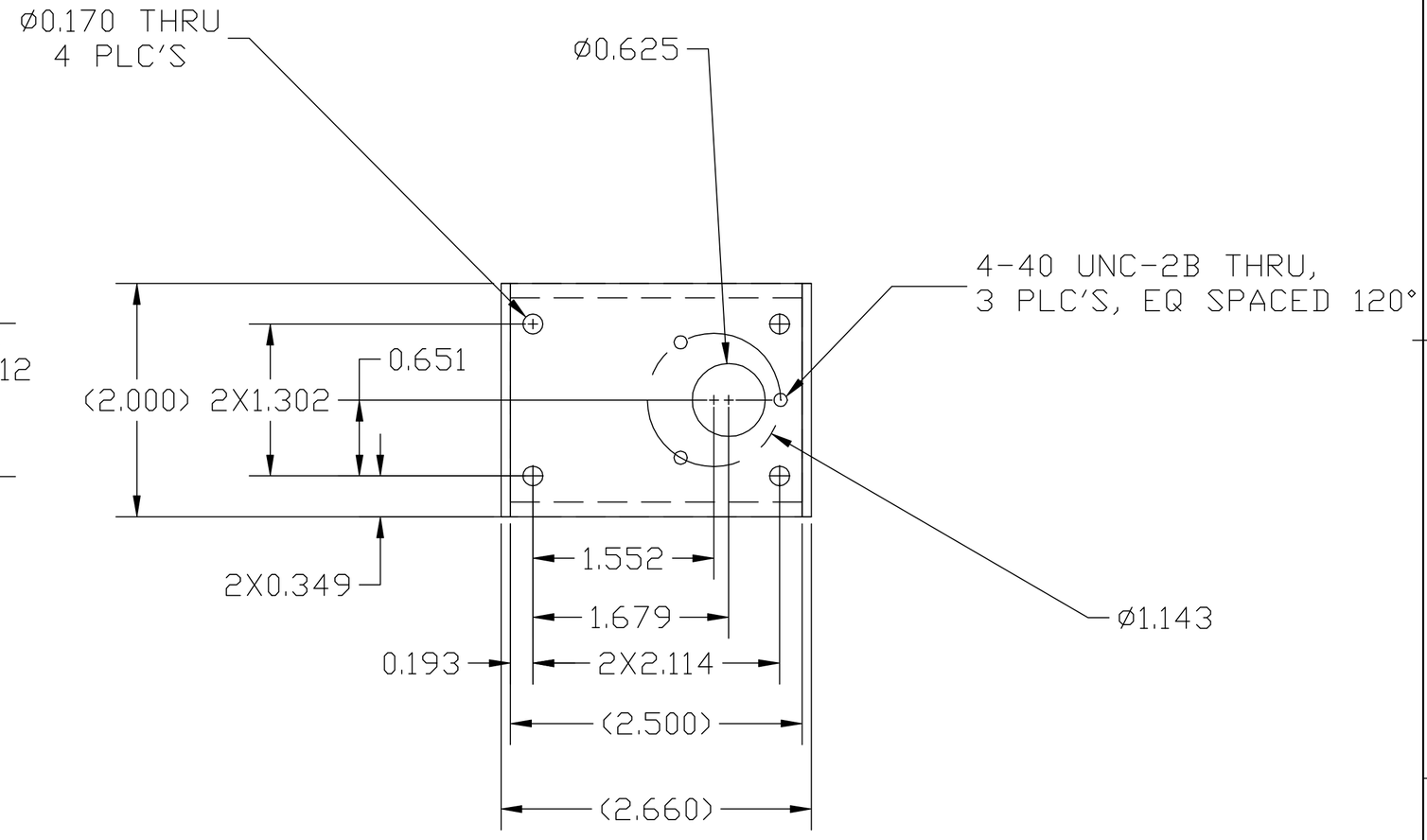
NOTES:

1. REMOVE AND RETAIN SIDE COVERS AND SCREWS PRIOR TO MACHINING.
2. MAKE FROM COMPAC DEVELOPMENT CORP. P/N S51110-250-0 (N). SUPPLIED BY MIT.







REF	QTY	PART or DRWG No.	CDS	MATERIAL

PARTS and MATERIAL LIST

UNLESS OTHERWISE SPECIFIED
DIMENSIONS ARE IN FEET [cm]
TOLERANCES:
FRACTIONAL ±1/16(.16)
ANGULAR ± 2°
TWO PLACE DECIMAL ±.01(.025)
THREE PLACE DECIMAL ± .005(.013)
FINISHED SURFACE RMS 63
BREAK CORNERS:.02
REMOVE ALL BURRS

MATERIAL: | HEAT TREAT: – | FINISH:

USED ON: – | NEXT ASS'Y: –

REV	DESCRIPTION	DCC	SYS	DET	CDS	VE	CC	BT	CHECK	DRWN	DATE
00	PRE-RELEASE									M. SMITH	6-22-98

ISSUE DESCRIPTION

DWG. NO.	DESCRIPTION

REFERENCE DRAWINGS

LIGO
CALIFORNIA INSTITUTE OF TECHNOLOGY
MASSACHUSETTS INSTITUTE OF TECHNOLOGY

PHOTO DIODE ENCLOSURE
PHOTO DIODE ASSEMBLY

CAD FILE	SIZE	DWG. NO.
D980302A.dwg	C	D980302-A-D

SCALE FULL | SHEET 1 of 1